

**ABSTRACT OF THE DISCLOSURE**

The invention is directed to a polypropylene resin which has a  $M_w/M_n$  of less than 5, a melt flow rate of less than 7 g/10 min., a 1% secant flexural modulus of greater  
5 than 300,000 psi and less than 2 wt.% xylene solubles.